

IN THE CLAIMS:

This Listing of Claims will replace all prior versions, and listings, of claims in the subject Patent Application:

Listing of Claims:

1. (Currently amended) An automatic package process for a card, comprising the steps of:

transferring a metal belt;

stamping said metal belt to form a first and second metal shells without releasing from said metal belt, said first and second metal shells having a plurality of strips extending therefrom;

bending said strips to form a plurality of stakes;

injection molding a first and second plastic frames on said first and second metal shells, respectively, said first and second plastic frames having said stakes embedded therein; and

combining said first and second plastic frames to form a case.

2. (Original) A process of claim 1, further comprising printing patterns on said first and second metal shells after forming said first and second plastic frames.

3. (Original) A process of claim 1, wherein said stamping for first and second metal shells comprises forming a plurality of strips on opposite sides of said metal shells.

4. (Original) A process of claim 3, further comprising bending said strips for forming stakes.

5. (Original) A process of claim 1, further comprising stamping said first metal shell for forming a bent extension.

6. (Original) A process of claim 4, wherein said first and second plastic frames embed said stakes on said first and second metal shells, respectively.

7. (Original) A process of claim 5, wherein said second plastic frame embeds said bent extension of said second metal shell.

8. (Original) A process of claim 1, wherein said first and second plastic frames are combined together by sonic welding.

9. (Original) A process of claim 1, wherein said metal belt is coated with an insulator film thereon.

10. (Original) A process of claim 1, further comprising removing said first and second metal shells from said metal belt after injection molding said first and second plastic frames.

11. (Currently amended) A package for a small card with a thickness not larger than 3.3 mm, said package comprising:

first and second metal shells each having a thickness not larger than 0.15 mm, a plurality of stakes extending therefrom, and an inner surface coated with an insulator film; and

first and second plastic frames embedding having said plurality of stakes embedded therein, to respectively, to form with said first and second metal shells first and second half cases, said first plastic frame having a thickness not larger than 0.7 mm, said second plastic frame having a thickness not larger than 1.4 mm;

wherein said first and second plastic frames are combined together to form a case.

12. (Original) A package of claim 11, wherein said first and second plastic frames have a recess.

13. (Original) A package of claim 11, wherein said second plastic frame has an I/O portion on which said second metal shell has a bent extension embedded therewith.

14. (Original) A package of claim 11, wherein said first and second plastic frames are combined by a glue.

15. (Original) A package of claim 11, wherein said first and second plastic frames are combined by a sonic welding.

16. (Currently amended) A package of claim 11, wherein said insulator film comprises a ~~Teflon~~ polytetrafluoroethylene material.

17. (New) A process of claim 1, wherein at least one of said first and second metal shells is stamped to include an elongate bent extension transversely disposed relative to a plurality of said stakes, said bent extension being embedded within one of said first and second plastic frames.

18. (New) A package of claim 11, wherein at least one of said first and second metal shells includes an elongate bent extension transversely disposed relative to a

MR3325-8

Serial Number: 10/657,122

Reply to Office Action dated 3 June 2005

plurality of said stakes, said bent extension being embedded within one of said first and second plastic frames.